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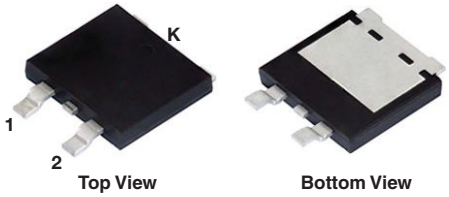
Dual High-Voltage Trench MOS Barrier Schottky Rectifier

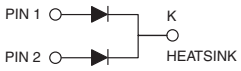
Ultra Low V_F = 0.60 V at I_F = 5.0 A

TMBS® eSMP® Series
SMPD (TO-263AC)



Top View Bottom View

V20DM150C



FEATURES

- Trench MOS Schottky technology
- Very low profile - typical height of 1.7 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available:
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE Available

RoHS COMPLIANT

HALOGEN FREE

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

MECHANICAL DATA

Case: SMPD (TO-263AC)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant
Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: as marked

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 x 10 A
V_{RRM}	150 V
I_{FSM}	120 A
V_F at I_F = 10 A (T_A = 125 °C)	0.69 V
T_J max.	175 °C
Package	SMPD (TO-263AC)
Diode variations	Common cathode

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)

PARAMETER		SYMBOL	V20DM150C	UNIT
Device marking code			V20DM150C	
Maximum repetitive peak reverse voltage		V_{RRM}	150	V
Maximum average forward rectified current (fig. 1)	per device	$I_{F(AV)}$ (1)	20	A
	per diode		10	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I_{FSM}	120	A
Operating junction temperature range		T_J (2)	-40 to +175	°C
Storage temperature range		T_{STG}	-55 to +175	

Notes

(1) Mounted on infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)						
PARAMETER	**TEST CONDITIONS**		**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Instantaneous forward voltage per diode	I_F = 5 A	T_A = 25 °C	V_F (1)	0.81	-	V
	I_F = 10 A			1.15	1.24	
	I_F = 5 A	T_A = 125 °C		0.6	-	
	I_F = 10 A			0.69	0.75	
Reverse current at rated V_R per diode	V_R = 100 V	T_A = 25 °C	I_R (2)	0.01	-	mA
		T_A = 125 °C		1.5	-	
	V_R = 150 V	T_A = 25 °C		-	0.15	
		T_A = 125 °C		3	10	
Typical junction capacitance	4.0 V, 1 MHz		C_J	530	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)			
PARAMETER	**SYMBOL**	**V20DM150C**	**UNIT**
Typical thermal resistance per device	$R_{\theta JC}$ (1)	2.0	°C/W
	$R_{\theta JA}$ (1)(3)	58	

Notes

(1) Mounted on infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$ - junction-to-ambient

(3) Free air, without heatsink

ORDERING INFORMATION (Example)				
PREFERRED P/N	**UNIT WEIGHT (g)**	**PACKAGE CODE**	**BASE QUANTITY**	**DELIVERY MODE**
V20DM150C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel
V20DM150CHM3/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

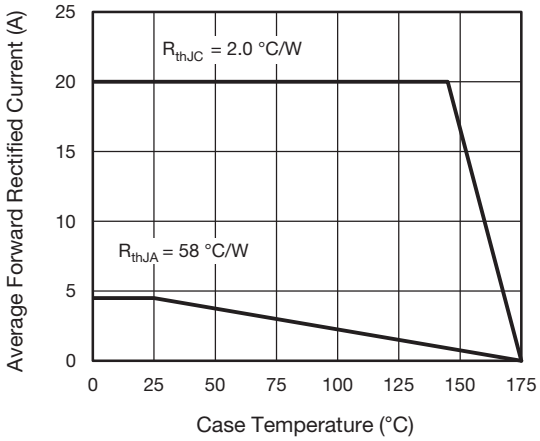


Fig. 1 - Maximum Forward Current Derating Curve

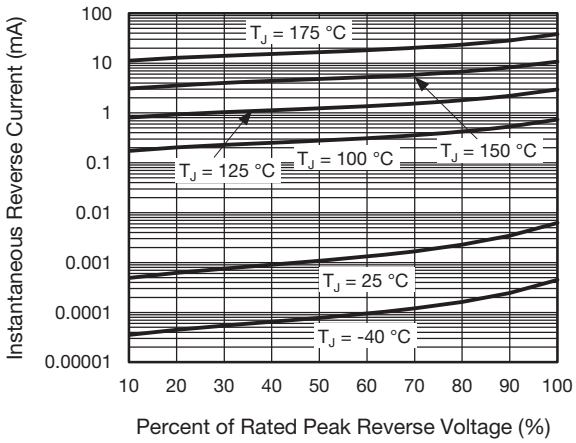


Fig. 4 - Typical Reverse Leakage Characteristics

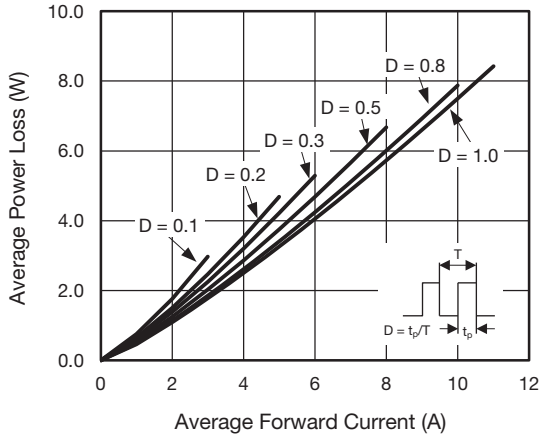


Fig. 2 - Average Power Loss Characteristics

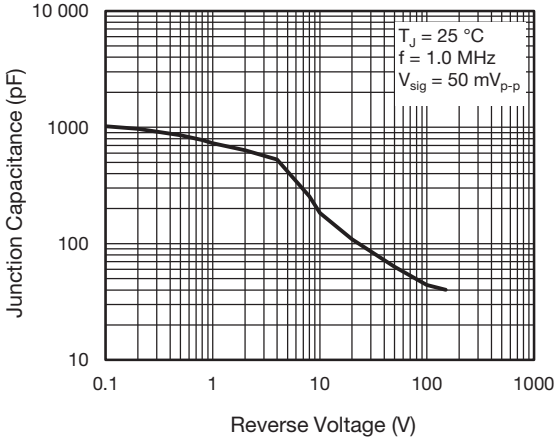


Fig. 5 - Typical Junction Capacitance

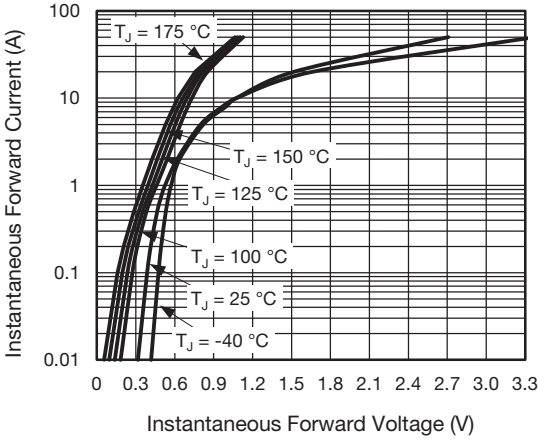


Fig. 3 - Typical Instantaneous Forward Characteristics

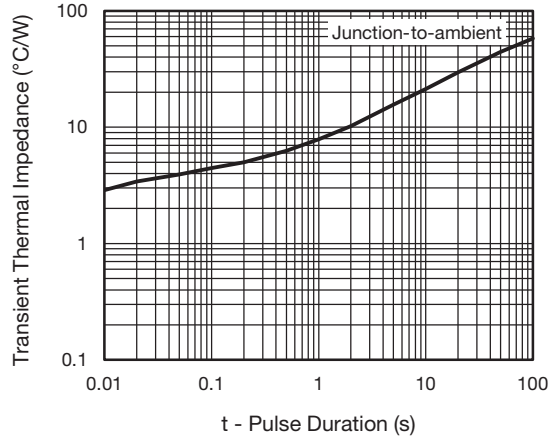


Fig. 6 - Typical Transient Thermal Impedance

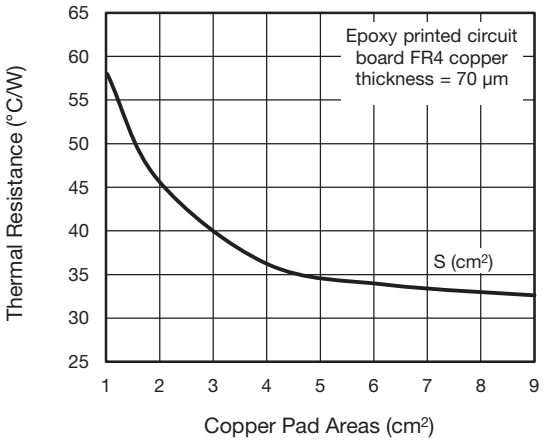
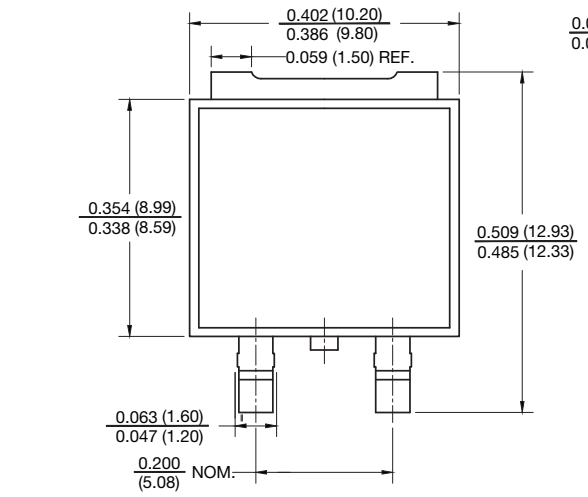
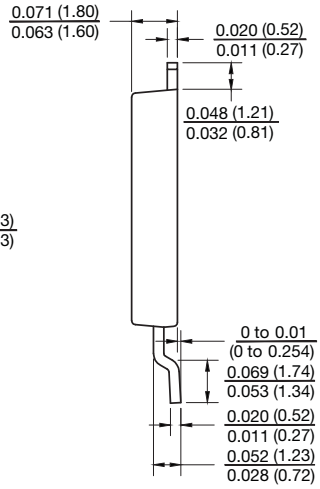


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

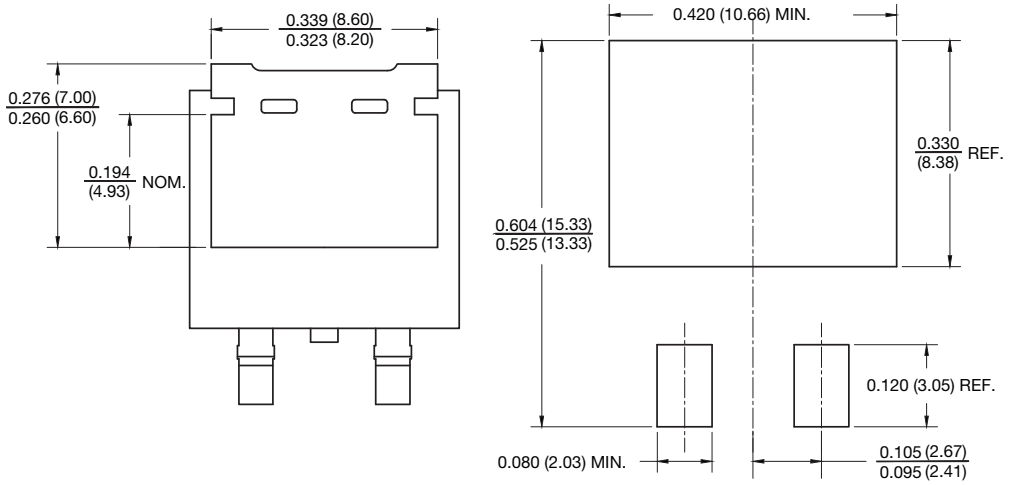
PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPD (TO-263AC)





Mounting Pad Layout



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